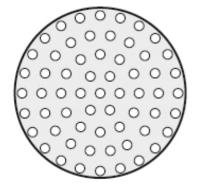
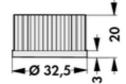
Details 23.11.10 08:56

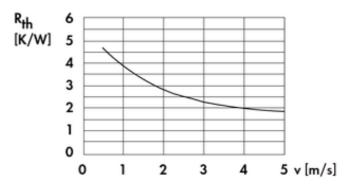
Pin heatsinks / ICK S R 32,5 x 20











 \emptyset 32,5 x 20 mm, pin heatsinks round

Parameters of article ICK S R 32,5 x 20

BauformRundRth [K/W]5.6dissipation loss [W]8.9

mounting method therm. conductive foil / therm. cond. adhesive

socket universal suitable for processor type universal Ø [mm] 32.5

heigth [mm] 20
plate thickness [mm] 3
weight [g] 13.8

Accessories/ related articles

Thermally conductive foil both sides adhesive / WLFT 404 D 32

Thermally conductive foil both sides adhesive / WLFT 405 D 32

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